

Microsemi Corporation

December 4, 2019

Product Discontinuance Notification (PDN) No: 389899

Subject: Product Discontinuance Notice for LX5564

Description:

Microsemi is announcing the discontinuance of the following product:

LX5564

Note that all packages and part variants for LX5564 are impacted, i.e., LX5564SP and LX5564SP-TR.

Reason for Discontinuance:

The decision to discontinue these products results from no sales and no forecast over the past 2 years.

Customer Impact:

Please contact your local Microsemi Sales Office for information regarding conversion to alternate parts.

Replacement Parts:

There are no pin compatible replacement devices. Please contact your local Microsemi Sales Office for more information on other product offerings.



Last Order Date: December 4, 2019

Last Shipment Date: December 4, 2019

Products Affected by this Discontinuance:

LX5564SP

LX5564SP-TR

Note: This is a list of Ordering Part Numbers (OPNs) as are found in product datasheets. Customers may track additional part number variants in their systems, so please consider this a base part list.

Contact Information:

Please contact your local <u>Microchip sales support</u> office with questions or concerns regarding this notification.

Any projected dates in this notification are based on the most current product information at the time this PDN is being issued, but they may change due to unforeseen circumstances. For the latest schedule and any other information, please contact your local Microsemi Sales Office, the factory contact shown above, or your local distributor.

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